



## Features

- Low driver power requirements (TTL/CMOS Compatible)
  - No moving parts
  - High reliability
  - Arc-Free with no snubbing circuits
  - 3750Vrms Input/Output isolation
- Telecommunications (PC, Electronic notepad)
  - Measuring and Testing equipment
  - Industrial control
  - Security equipments
  - High speed inspection machine

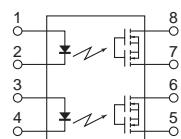
## Applications



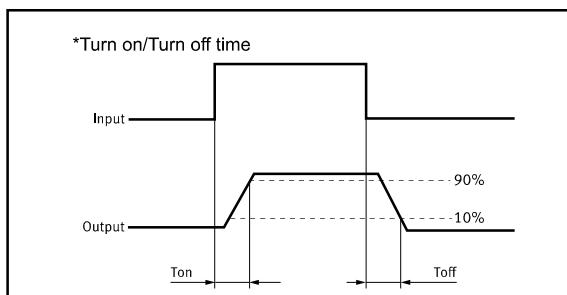
SMD-8



DIP-8



1.3. LED Anode  
2.4. LED Cathode  
5.6. Drain (MOS FET)  
7.8. Drain (MOS FET)



## TYPES

Category	Output rating				Packing quantity
	Load voltage	Load current	Part No.	Package	
AC/DC	400V	150mA	GAQW214E	DIP-8	25pcs/Tube
			GAQW214EH	SMD-8	1000pcs/1reel

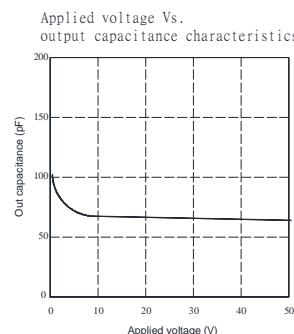
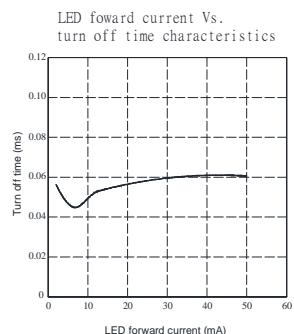
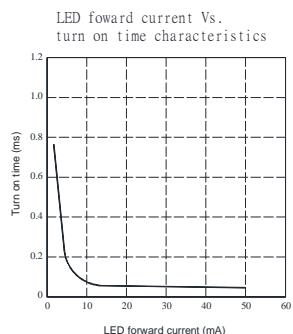
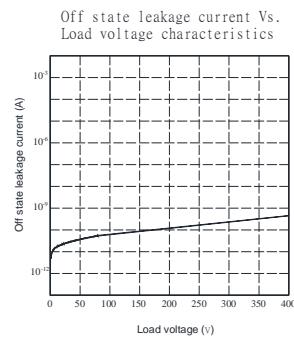
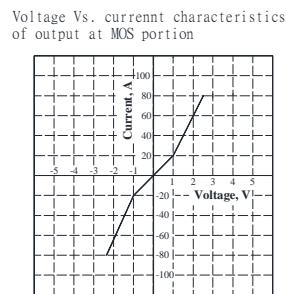
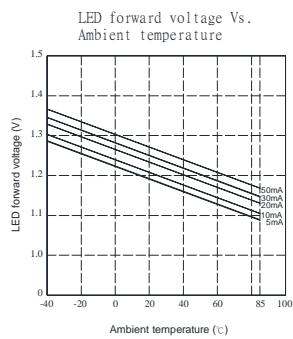
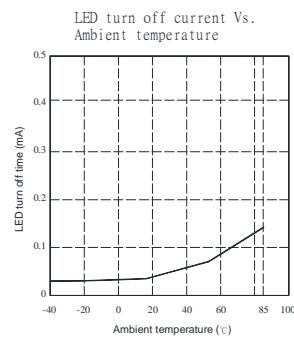
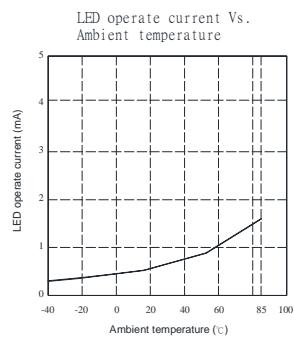
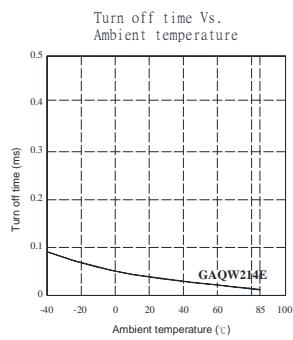
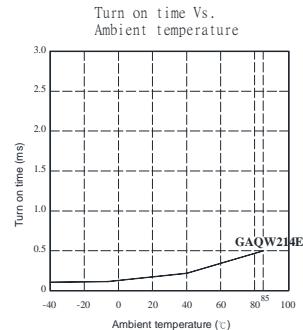
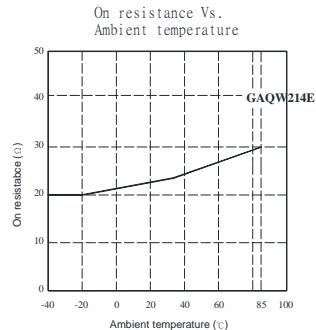
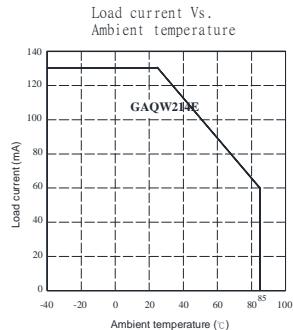
## Absolute Maximum Ratings (Ambient Temperature: 25°C)

Item	Symbol	Value	Units	Note
Input	Continuous LED Current	I <sub>F</sub>	50	mA
	Peak LED Current	I <sub>FP</sub>	1000	mA f=100Hz, duty=1%
	LED Reverse Voltage	V <sub>R</sub>	5	V
	Input Power Dissipation	P <sub>In</sub>	75	mW
Output	Load Voltage	V <sub>L</sub>	400	V(AC peak or DC)
	Load Current	I <sub>L</sub>	150	mA
	Peak Load Current	I <sub>Peak</sub>	0.8	A 100ms(1 pulse)
	Output Power Dissipation	P <sub>out</sub>	750	mW
Total Power Dissipation	P <sub>T</sub>	800	mW	
I/O Breakdown Voltage	V <sub>I/O</sub>	3750	Vrm	RH=60%, 1min
Operating Temperature	T <sub>Opr</sub>	-40 to +85	°C	
Storage Temperature	T <sub>Sig</sub>	-40 to +100	°C	
Pin Soldering Temperature	T <sub>Sol</sub>	260	°C	10 sec max.

## Electrical Specifications (Ambient Temperature: 25°C)

Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	V <sub>F</sub>	1.23	1.3	1.50	V I <sub>F</sub> =10mA
	Operation LED Current	I <sub>F On</sub>		0.9	3.0	mA
	Recovery LED Current	I <sub>F Off</sub>		0.35	0.5	mA
	Recovery LED Voltage	V <sub>F Off</sub>	0.5	1.2	V	
Output	On-Resistance	R <sub>On</sub>		14	18	Ω I <sub>F</sub> =5mA, I <sub>L</sub> =100mA, Time to flow is within 1 sec.
	Off-State Leakage Current	I <sub>Leak</sub>			0.1	uA V <sub>L</sub> =Rating
	Output Capacitance	C <sub>out</sub>		58	pF	V <sub>L</sub> =0, f=1MHz
Transmission	Turn-On Time	T <sub>On</sub>		0.3	1.0	ms I <sub>F</sub> =5mA, I <sub>L</sub> =100mA,
	Turn-Off Time	T <sub>Off</sub>		0.03	0.5	ms
Coupled	I/O Isolation Resistance	R <sub>I/O</sub>	10 <sup>10</sup>		Ω	DC500V
	I/O Capacitance	C <sub>I/O</sub>		0.8	1.5	pF f=1MHz

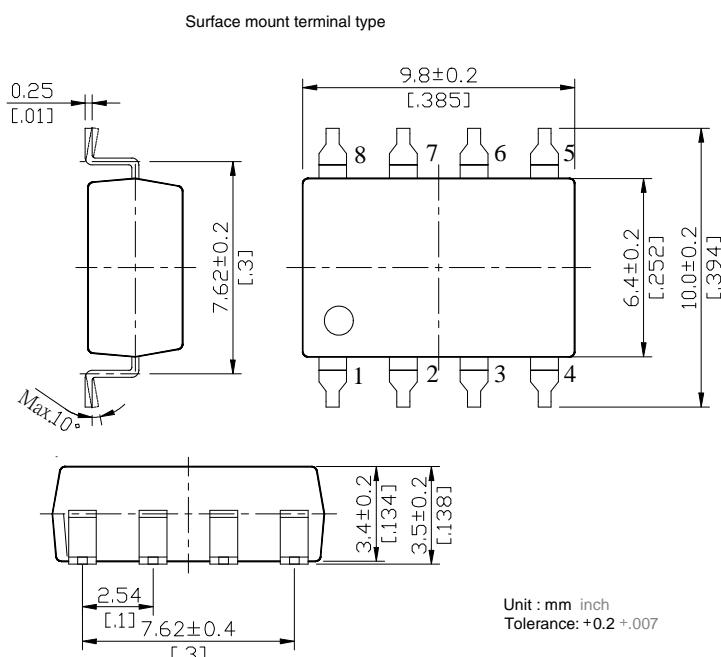
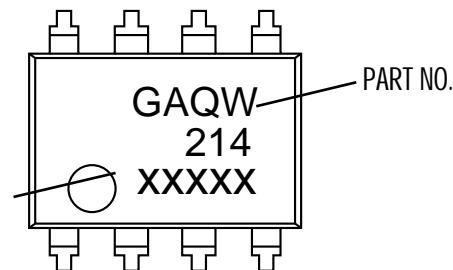
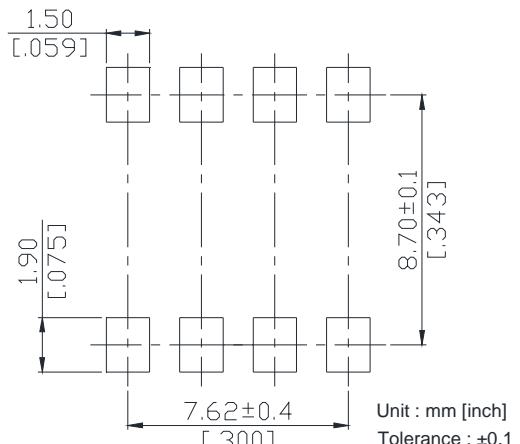
#### Reference Data



**8-SMD**

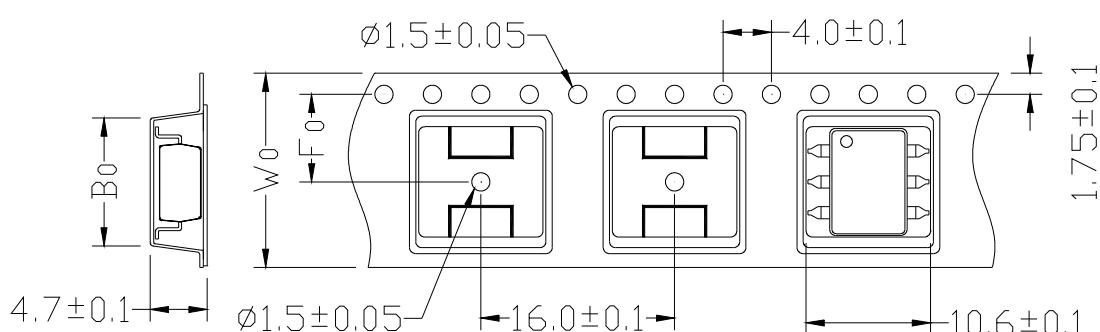

Dimensions

mm inch

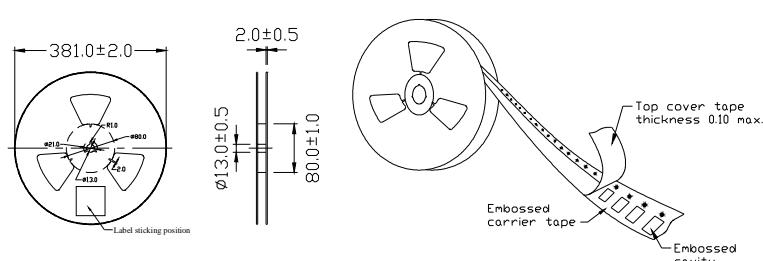

 PC board pattern  
(Top view)


Tape dimensions

Direction of feed →



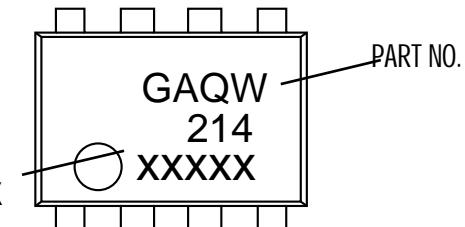
Dimensions of tape reel



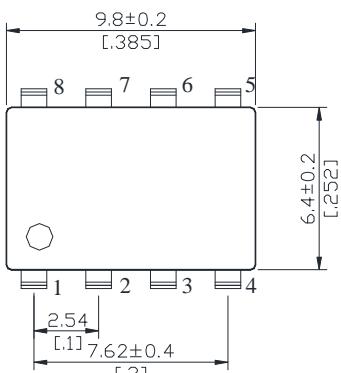
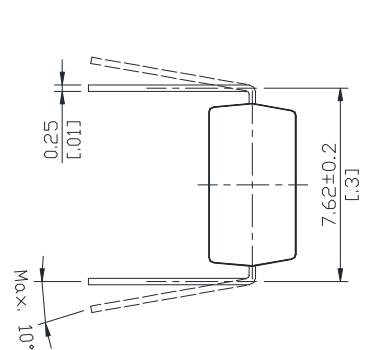
## 8-DIP

### Dimensions

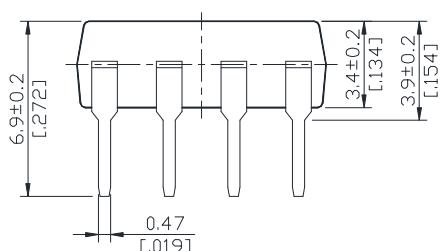
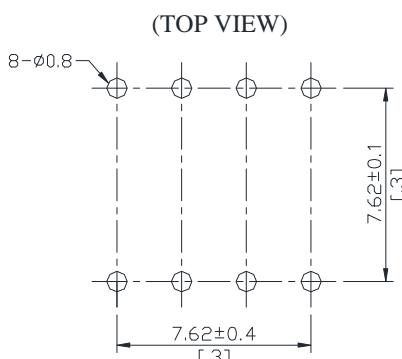
mm inch



Through hole terminal type



PC board pattern



Unit : mm inch  
Tolerance: +0.2 -.007

## DIP type

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.

